

## XFP-10MM85-3HC

10Gbps XFP Transceiver, Multi Mode, 300m Reach

### **Features**

- Supports 8.0Gb/s to 11.1Gb/s bit rates
- Hot-pluggable XFP footprint, Built-in digital diagnosis
- Maximum link length of 300m with MMF-OM3
- 850nm VCSEL laser and PIN photodiode
- XFP MSA package with duplex LC connector
- No reference clock required
- Single +3.3V power supply
- Power dissipation <1.5W</li>
- Compatible with RoHS
- Temperature range: 0 to +70°C

## **Applications**

- SONET OC-192&SDH STM-64 at 9.953Gbps
- 10GBASE-SR/SW 10G Ethernet
- 1200-MX-SN-I 10Gigabit Fiber Channel
- 10GE over G.709 at 11.09Gbps
- OC192 over FEC at 10.709Gbps
- Other optical links, up to 11.3Gbps

### **Description**

The XFP module is compliant with the 10G Small Form-Factor Pluggable (XFP) Multi-Source Agreement (MSA), supporting data-rate of 8.0~11.1Gbps, and transmission distance up to 300m with OM3 MMF.

The transceiver module comprises a transmitter with 850nm VCSEL laser and a receiver with a PIN photodiode. Transmitter and receiver are separate within a wide temperature range and offers optimum heat dissipation and excellent electromagnetic shielding thus enabling high port densities for 10 Gbps systems.



# **Absolute Maximum Ratings**

# **Table 1- Absolute Maximum Ratings**

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

Any stress beyond the maximum ratings can result in permanent damage. The device specifications are guaranteed only under the recommended operating conditions.

# **Recommended Operating Conditions**

**Table 2- Recommended Operating Conditions** 

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Тс	0		+70	°C
Power Supply Voltage @3.3V	Vcc	3.135	3.30	3.465	V
Power Supply Current	Icc			500	mA
Data Rate		8.0		11.1	Gbps

# **Optical and Electrical Characteristics**

**Table 3- Optical and Electrical Characteristics** 

Parameter		Symbol	Min	Typical	Max	Unit	Notes
			Transm	itter			
Centre V	Vavelength	λс	840	850	860	nm	
Spectral Width (RMS)		Δλ			0.45	nm	
Side-Mode Suppression Ratio		SMSR	-	-	-	dB	
Average Output Power		P <sub>out</sub>	-6.5		-0.5	dBm	1
Extinction Ratio		ER	3.0			dB	
Data Input Swing Differential		V <sub>IN</sub>	180		950	mV	2
Input Differential Impedance		Z <sub>IN</sub>	90	100	110	Ω	
TX Disable	Disable		2.0		Vcc	V	
	Enable		0		0.8	V	
	I		Recei	ver			





Centre Wavelength	λο	840		860	nm	
Receiver Sensitivity				-11.1	dBm	3
Receiver Overload		0.5			dBm	3
LOS De-Assert	LOS <sub>D</sub>			-12	dBm	
LOS Assert	LOSA	-26			dBm	
LOS Hysteresis		0.5		4	dB	
Data Output Swing Differential	V <sub>out</sub>	400	600	800	mV	2
LOS	High	2.0		Vcc	V	
	Low			0.8	V	

### Notes:

- The optical power is launched into MMF.
   Internally AC-coupled.
   Measured with a PRBS 231-1 test pattern @9953Mbps, BER ≤1×10-12.

Pin Descriptions
Table 4- Pin Descriptions

Pin	Logic	Symbol	Name/Description	Re
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – <b>Not required</b>	
3	LVTTL-I	Mod- Desel	Module De-select; When held low allows the module to, respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply – <b>Not required</b>	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock	2
11	LVTTL- I/O	SDA	Serial 2-wire interface data line	2
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTL-O	Mod_NR	Module Not Ready;	2
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	

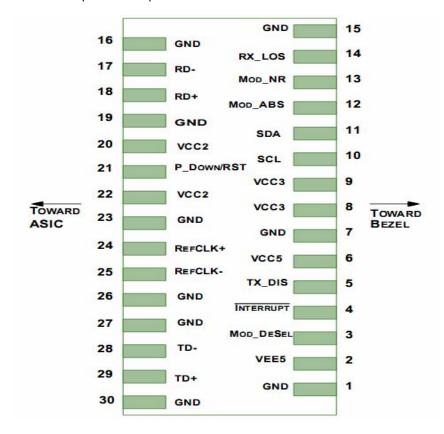




18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply – <b>Not required</b>	
21	LVTTL-I	P_Down/R ST	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
			Reset; The falling edge initiates a complete reset of the module including the 2- wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply – <b>Not required</b>	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – <b>Not</b> required	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – <b>Not required</b>	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

#### Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector, should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15Vand 3.6V.
- 3. A Reference Clock input is not required.



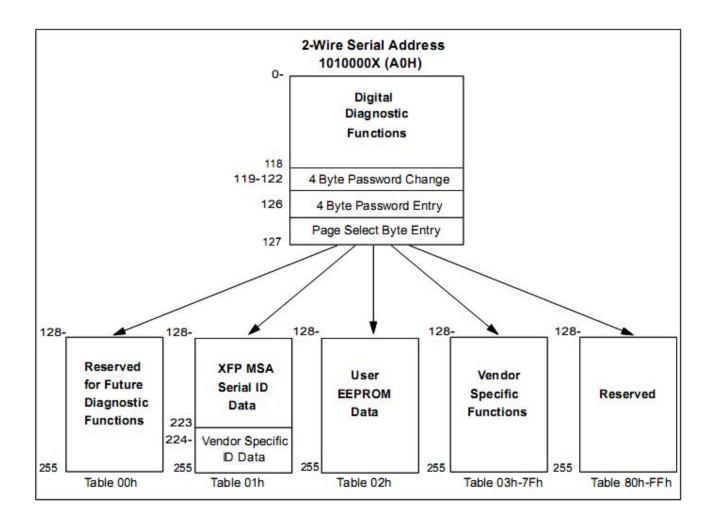


## **Management Interface**

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

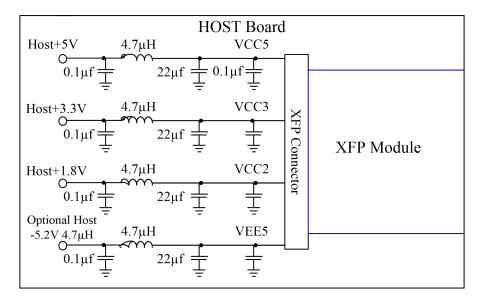
The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented.

The digital diagnostic memory map specific data field defines as following.

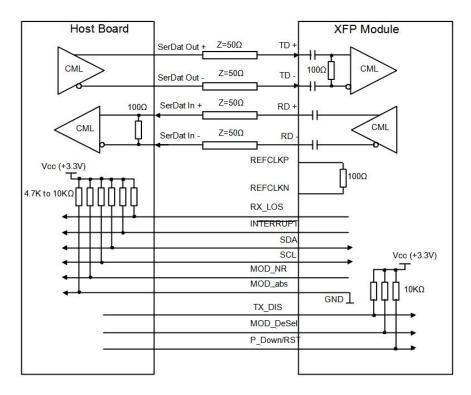




# **Recommended Host Board Power Supply Circuit**

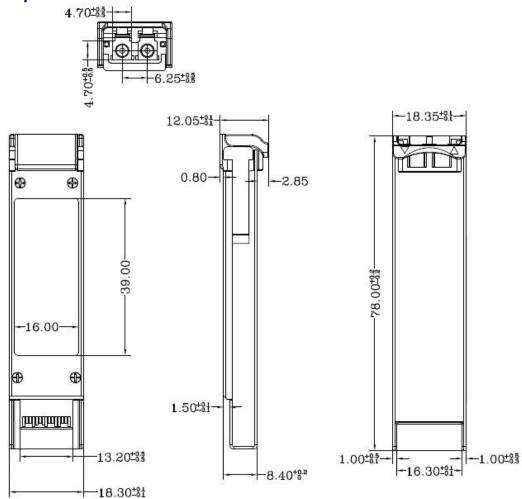


# **Recommended High-speed Interface Circuit**





# **Mechanical Specifications**



# **Ordering information**

**Table 5- Ordering information** 

Table & Classing	mormation
Part Number	Product Description
XFP-10MM85-3HC	8.0~11.1Gbps, 850nm, OM3 MMF, 300m, 0°C ~ +70°C

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